

POC-400 Series

Intel® Elkhart Lake Atom® x6425E Ultra-compact Fanless Embedded Computer with 2.5GbE & PoE+



Key Features

- · Intel® Elkhart Lake Atom® x6425E quad-core 2.0GHz/ 3.0GHz 12W processor
- · Rugged -25 °C to 70 °C fanless operation
- · 2x 2.5GbE PoE+ ports and 1x 2.5GbE port with screw-lock
- · 2x USB 3.1 Gen1 and 2x USB 2.0 ports with screw-lock
- · M.2 2280 M key SATA interface
- · Dual DP display outputs supporting 4096 x 2160 resolution
- · Front I/O access DIN-mounting design
- MezIO[™] compatible

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Introduction

POC-400 is an ultra-compact fanless embedded computer for industrial applications. It utilizes the latest Intel[®] Elkhart Lake platform Atom[®] x6425E 4-core CPU that can deliver 1.8x CPU and 2x GPU performance improvement, compared to the previous generation.

In addition to the performance boost, POC-400 features an ultra-compact design measuring just $56 \times 108 \times 153$ mm, which can easily fit into restricted spaces. The system comes with a DIN-rail mounting chassis and an abundance of front-access I/O interfaces. Featuring three 2.5GBASE-T Ethernet ports with IEEE 802.3 PoE+ capability, they provide higher data bandwidth for devices such as NBASE-T cameras and is backward-compatible with 1000/100/10 Mbps Ethernet. It also has two 4K DisplayPort, 2x USB3.1 Gen1, 2x USB 2.0 and COM ports for general industrial applications.

Supporting Neousys' proprietary MezIO™ interface for function expansion, you can add functions such as isolated DIO, RS-232/422/485, ignition control and 4G/ 5G by installing a MezIO™ module. Moreover, POC-400 comes with an internal M.2 E key socket for a Google TPU or an Intel® Movidius VPU module to transform it into a lightweight AI inference platform at the edge.

Combining the new 10nm Atom® CPU, 2.5G Ethernet ports, PoE+ and ultra-compact enclosure with function expansion capabilities, Neousys' POC-400 is a compact and yet versatile embedded computer that can fuel various industrial applications.

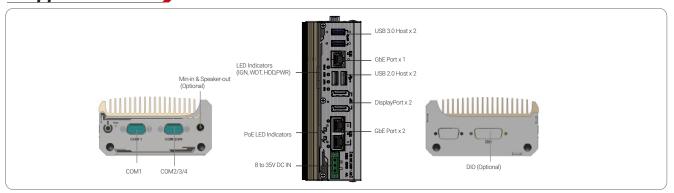
Specifications

| System Core | |
|-----------------|---|
| Processor | Intel® Elkhart Lake Atom® x6425E quad-core 2.0GHz/3.0GHz 12W processor |
| Graphics | Integrated Intel [®] UHD Graphics |
| Memory | Up to 32 GB DDR4-3200 SDRAM by one SODIMM socket |
| Panel I/O Inter | face |
| Ethernet | 3x 2.5GBASE-T Ethernet ports by Intel® I225 GbE controllers |
| PoE | Optional IEEE 802.3at PoE+ on port #2 and #3 |
| Video Port | 2x DisplayPort connector, supporting 4096 x 2160 resolution @ 60Hz |
| USB 3.1 | 2x USB 3.1 Gen1 (5 Gbps) ports |
| USB 2.0 | 2x USB 2.0 ports |
| Serial Port | 1x software-programmable RS-232/422/485 ports (COM1) 3x 3-wire RS-232 ports (COM2/3/4) or 1x RS-422/485 port (COM2) |
| Audio | Optional 1x 3.5 mm jack for mic-in and speaker-out |
| Internal Expan | sion Bus |
| M.2 E key | 1x M.2 2230 E key socket for WiFi, Google TPU or Movidius VPU module |
| Expandable I/O | 1x MezlO™ expansion port for Neousys MezlO™ modules |

| Storage Interfa | Storage Interface | | |
|--------------------------|---|--|--|
| M.2 M key | 1x M.2 2280 SATA interface | | |
| Power Supply | | | |
| DC Input | 1x 3-pin pluggable terminal block for 8 to 35V DC input | | |
| Mechanical | | | |
| Dimension | 56 mm (W) x 108 mm (D) x 153 mm (H) | | |
| Weight | 0.96 kg | | |
| Mounting | DIN-rail mount (standard) or Wall-mount (optional) | | |
| Environmental | | | |
| Operating Temperature | -25°C ~ 70°C | | |
| Storage Temperature | -40°C ~85°C** | | |
| Humidity | 10%~90%, non-condensing | | |
| Vibration | Operating, MIL-STD-810G, Method 514.7, Category 4 | | |
| Shock | Operating, MIL-STD-810G, Method 516.7, Procedure I | | |
| EMC | CE/FCC Class A, according to EN 55032 & EN 55035 | | |



Appearance



Dimensions



Ordering Information

| Model No. | Product Description | |
|--|--|--|
| POC-400 | Intel® Elkhart Lake Atom® x6425E ultra-compact DIN-rail fanless rugged computer with 1x 2.5GbE, 2x 2.5G PoE+ and 2x USB 3.1 Gen1 | |
| POC-410 | Intel® Elkhart Lake Atom® x6425E ultra-compact DIN-rail fanless rugged computer with 3x 2.5GbE and 2x USB 3.1 Gen1 | |
| Optional 1x 3.5 mm jack for mic-in and speaker-out | | |

Optional Accessories

| PA-60W-OW | 60W AC/DC power adapter with 12V, 5A DC output, cord end terminals for terminal block. Operating temperature: -30 to 60 °C |
|---------------------|--|
| Wmkit-V-POC400 | Wall-mount assembly for POC-400 series, vertical type |
| Wmkit-H-POC400 | Wall-mount assembly for POC-400 series, horizontal type |
| Cbl-DB9F-3DB9M-15CM | 1x DB9 (Female) to 3x DB9 (Male), length: 15CM |

MezIO[™] Modules

| MezIO [™] -C180 | MezIO™ module with 4x RS-232/ 422/ 485 ports and 4x RS-232 ports |
|--------------------------|---|
| MezIO [™] -C181 | MezIO™ module with 4x RS-232/ 422/ 485 ports and 4x RS-422/ 485 ports |
| MezIO [™] -D220 | MezIO™ module with 8-CH isolated digital input and 8-CH isolated digital output |
| MezIO [™] -D230 | MezIO™ module with 16-CH isolated digital input and 16-CH isolated digital output |
| MezIO [™] -V20 | MezIO™ module with ignition power control function and 1x mini-PCle socket for in-vehicle usage |
| MezIO [™] -U4 | MezIO™ module with 4x USB 3.1 ports |
| MezIO [™] -R11 | MezIO™ module with SATA port for 2.5" HDD/ SSD |
| MezIO [™] -R12 | MezIO™ module with SATA port for 2.5" HDD/ SSD, 4-CH isolated DI and 4-CH isolated DO |
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